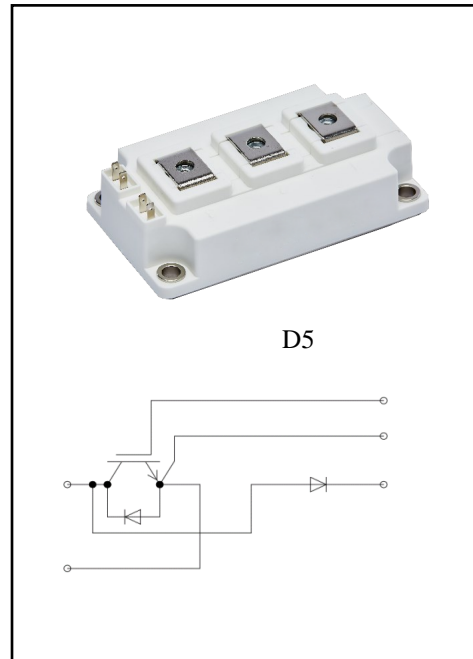


62mm Chopper IGBT Module

$V_{CES}=1200V$, $I_{C\ nom}=300A$ / $I_{CRM}=600A$

Electrical characteristics :

- 1200V Trench /Field Stop process
- Low switching losses
- V_{cesat} has a positive temperature coefficient



Applications:

- High Frequency Power Supplies
- UPS
- Variable Frequency Drive

IGBT, Inverter

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Collector-Emitter voltage	$T_{vj}=25^{\circ}C$	V_{CES}	1200	V
Continuous DC collector current	$T_C=100^{\circ}C$, $T_{vj\ max}=175^{\circ}C$	$I_{C\ nom}$	300	A
Repetitive peak collector current	$t_p=1\ ms$	I_{CRM}	600	A
Total power dissipation	$T_C = 25^{\circ}C$, $T_{vj\ max} = 175^{\circ}C$	P_{tot}	1470	W
Gate emitter voltage		V_{GE}	± 20	V

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	$V_{GE}=15V, I_C=300A$ $V_{GE}=15V, I_C=300A$ $V_{GE}=15V, I_C=300A$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	V_{CEsat}	2.23 2.74 2.86	2.70	V
Gate-Emitter threshold voltage	$I_C=8mA, V_{GE}=V_{CE}$	$T_{vj}=25^{\circ}C$	$V_{GE(th)}$	5.00 5.65	6.20	
Gate charge	$V_{GE}=-15V...+15V$		Q_G	1.52		μC
Internal gate resistor			R_{Gint}	2.0		Ω
Input capacitance	$f=1\text{ MHz}, V_{CE}=25\text{ V}, V_{GE}=0\text{ V}$	$T_{vj}=25^{\circ}C$	C_{ies}	22.53		nF
Reverse transfer capacitance			C_{res}	0.85		nF
Collector-emitter cut-off current	$V_{CE}=1200V, V_{GE}=0\text{ V}$	$T_{vj}=25^{\circ}C$	I_{CES}		1	mA
Gate-emitter leakage current	$V_{CE}=0\text{ V}, V_{GE}=20\text{ V}$	$T_{vj}=25^{\circ}C$	I_{GES}		200	nA
Turn-on delay time	$I_C=300A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=2.5\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_{d\ on}$	196 205 209		
Rise time	$I_C=300A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=2.5\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	t_r	56 61 62		
Turn-off delay time	$I_C=300A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=2.5\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_{d\ off}$	257 294 303		ns
Fall time	$I_C=300A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=2.5\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	t_f	85 141 136		
Turn-on energy loss per pulse	$I_C=300A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=2.5\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	E_{on}	9.47 19.02 22.82		mJ
Turn-off energy loss per pulse	$I_C=300A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=2.5\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	E_{off}	18.28 22.20 23.10		
SC data	$V_{GE}\leq 15V, V_{cc}=800V$ $V_{CEmax}=V_{CES}-L_{sCE}\cdot di/dt$	$t_p\leq 10\mu s, T_{vj}=150^{\circ}C$	I_{sc}	979		A
Thermal resistance, junction to case	per IGBT		R_{thJC}		0.10	K/W
Temperature under switching conditions			$T_{vj\ op}$	-40	150	$^{\circ}C$

Diode, Inverter

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Repetitive peak reverse voltage	$T_{vj}=25^{\circ}\text{C}$	V_{RRM}	1200	V
Continuous DC forward current		I_F	300	A
Repetitive peak forward current	$t_p=1\text{ms}$	I_{FRM}	600	A
I^2t -value	$t_p=10\text{ms}$, $\sin 180^{\circ}$, $T_j=125^{\circ}\text{C}$	I^2t	4050	A^2s

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F=300\text{A}$, $V_{GE}=0\text{V}$ $T_{vj}=25^{\circ}\text{C}$ $I_F=300\text{A}$, $V_{GE}=0\text{V}$ $T_{vj}=125^{\circ}\text{C}$ $I_F=300\text{A}$, $V_{GE}=0\text{V}$ $T_{vj}=150^{\circ}\text{C}$	V_F		2.23 2.31 2.24	2.75	V
Peak reverse recovery current	$I_F=300\text{A}$, $T_{vj}=25^{\circ}\text{C}$ $-\text{di}_F/\text{dt}=4233\text{A}/\mu\text{s}$ ($T_{vj}=150^{\circ}\text{C}$) $T_{vj}=125^{\circ}\text{C}$ $V_R=600\text{V}$, $V_{GE}=-15\text{V}$ $T_{vj}=150^{\circ}\text{C}$	I_{RM}		186 218 230		A
Recovered charge	$I_F=300\text{A}$, $T_{vj}=25^{\circ}\text{C}$ $-\text{di}_F/\text{dt}=4233\text{A}/\mu\text{s}$ ($T_{vj}=150^{\circ}\text{C}$) $T_{vj}=125^{\circ}\text{C}$ $V_R=600\text{V}$, $V_{GE}=-15\text{V}$ $T_{vj}=150^{\circ}\text{C}$	Q_F		11.30 29.50 38.40		μC
Reverse recovered energy	$I_F=300\text{A}$, $T_{vj}=25^{\circ}\text{C}$ $-\text{di}_F/\text{dt}=4233\text{A}/\mu\text{s}$ ($T_{vj}=150^{\circ}\text{C}$) $T_{vj}=125^{\circ}\text{C}$ $V_R=600\text{V}$, $V_{GE}=-15\text{V}$ $T_{vj}=150^{\circ}\text{C}$	E_{rec}		5.25 12.71 16.10		mJ
Thermal resistance, junction to case	per diode	R_{thJC}			0.15	K/W
Temperature under switching conditions		$T_{vj\ op}$	-40		150	$^{\circ}\text{C}$

Module

Parameter	Conditions	Symbol	Value			Unit
Isolation test voltage	RMS, $f=50\text{Hz}$, $t=1\text{min}$	V_{ISOL}	4000			V
Internal isolation			Al_2O_3			
Storage temperature		T_{stg}	-40		125	$^{\circ}\text{C}$
Mounting torque for modul mounting		M	3.0		6.0	Nm
Weight		W		313		g

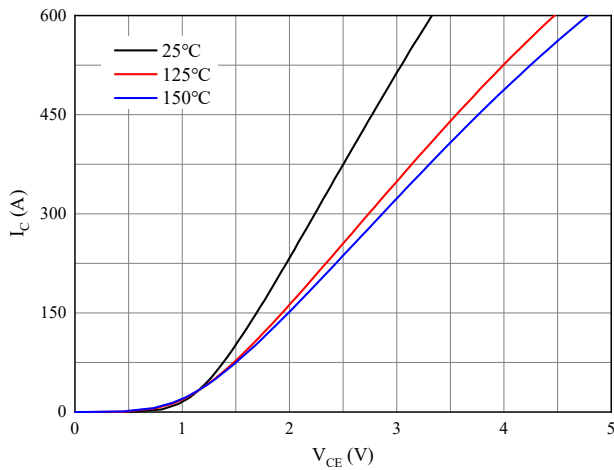


Fig 1. Typical output characteristics ($V_{GE}=15V$)

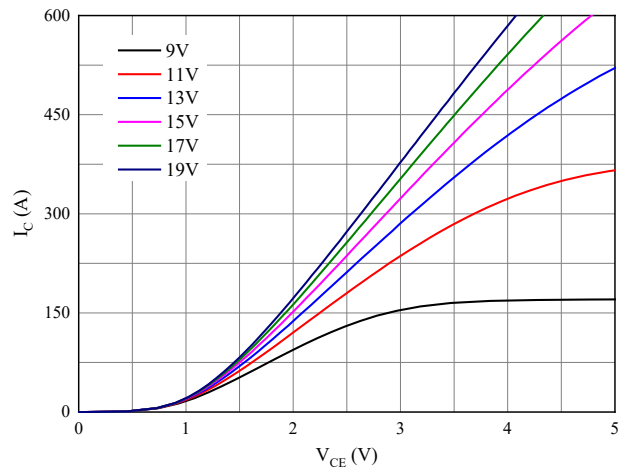


Fig 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

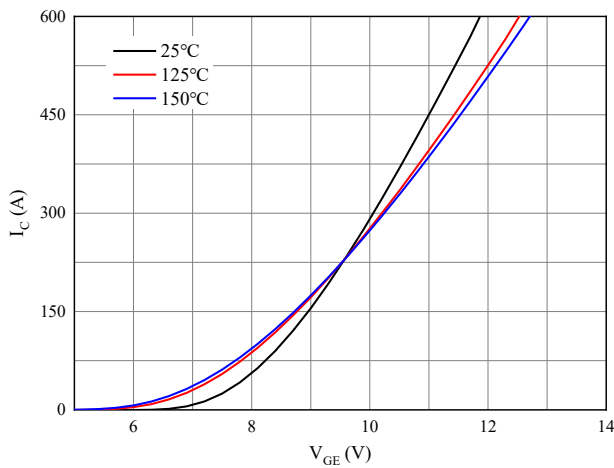


Fig 3. Typical transfer characteristic ($V_{CE}=20V$)

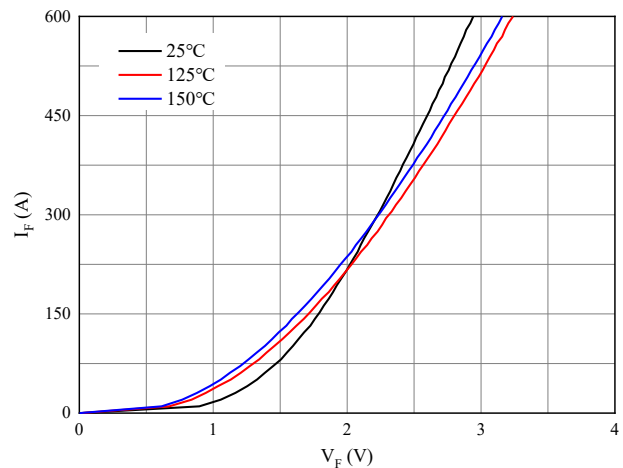


Fig 4. Forward characteristic of Diode

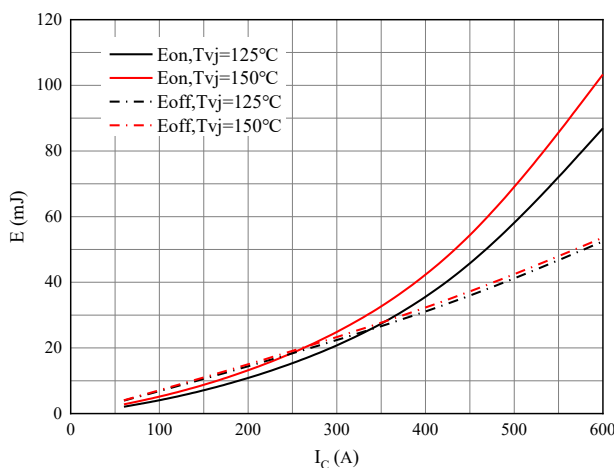


Fig 5. Switching losses of IGBT
 $V_{GE}=\pm 15V, R_{Gon}=2.5\Omega, R_{Goff}=2.5\Omega, V_{CE}=600V$

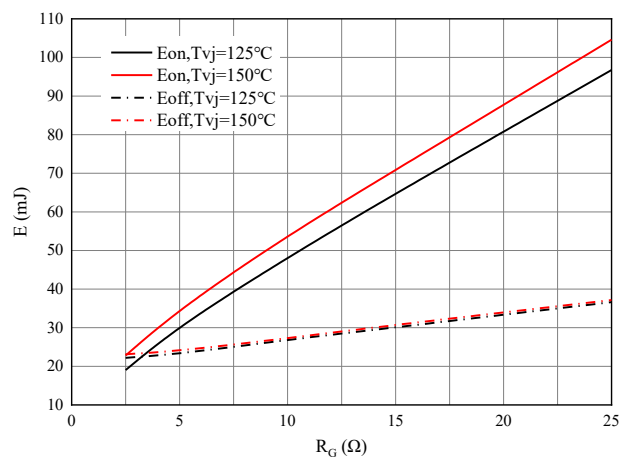


Fig 6. Switching losses of IGBT
 $V_{GE}=\pm 15V, I_C=300A, V_{CE}=600V$

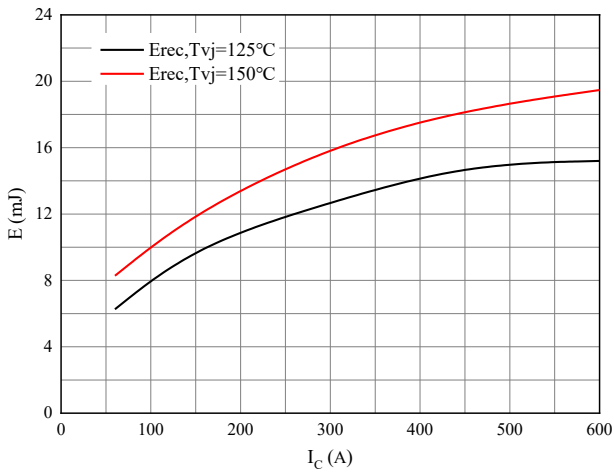


Fig 7. Switching losses of Diode
 $R_{Gon}=2.5\Omega, V_{CE}=600V$

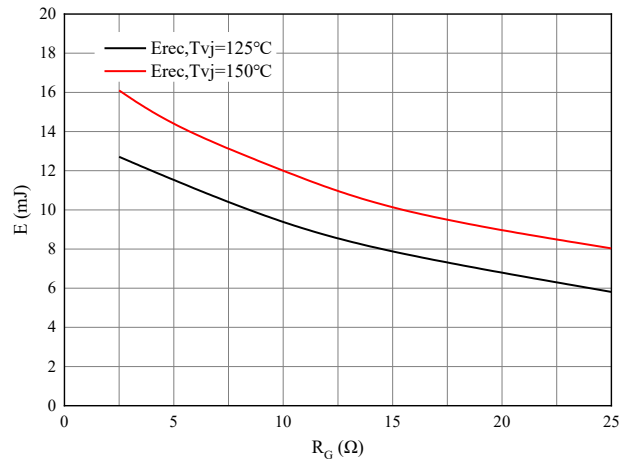


Fig 8. Switching losses of Diode
 $I_F=300A, V_{CE}=600V$

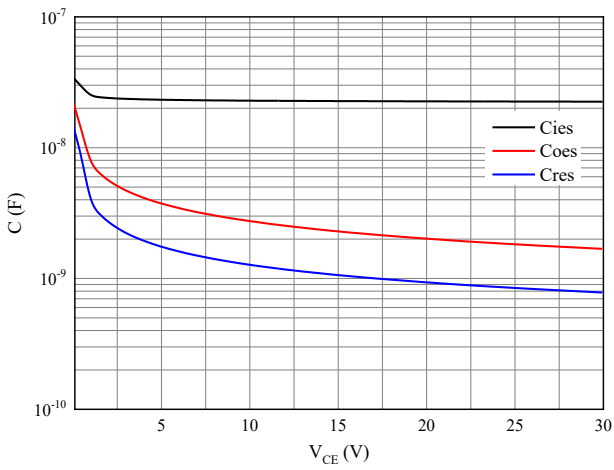
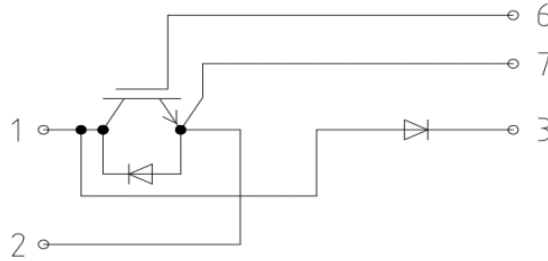


Fig 9. Capacitance characteristic

Circuit diagram



Package outlines

